L Number	Hits	Search Text	DB	Time stamp
57	1189	257/692.ccls.	USPAT;	2002/04/03 18:41
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			1	
50	505	057/601	IBM_TDB	0000/04/03 10 40
58	727	257/691.ccls.	USPAT;	2002/04/03 18:42
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
59	635	257/691.ccls. not 257/692.ccls.	USPAT;	2002/04/03 18:56
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	:
			IBM TDB	
60	14	257/776.ccls. and ((external or power) adj (terminal or lead))	USPAT;	2002/04/03 19:11
			ì	2002/04/03 13:11
			US-PGPUB;	
			EPO; JPO;	
:			DERWENT;	
			IBM_TDB	
61	34	257/777.ccls. and ((external or power) adj	USPAT;	2002/04/03 19:21
		(terminal or lead))	US-PGPUB;	İ
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
62	1	("6208521").PN.	USPAT	2002/04/03 19:39
63	550	,	USPAT;	2002/04/03 19:39
	200		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	222	261/702 cala and (terminal on load)	USPAT;	2002/04/03 19:40
64	333	361/783.ccls. and (terminal or lead)		2002/04/03 19.40
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
65	307	(361/783.ccls. and (terminal or lead)) and	USPAT;	2002/04/03 19:41
1		(device or chip or die)	US-PGPUB;	
 - -			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	497	(semiconductor adj device) and (power adj	USPAT;	2002/04/03 13:12
	10,	terminal)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	1
· [IBM TDB	
_	548	1 . 3	_	2002/04/03 13:20
			USPAT;	2002/04/03 13:20
		(power adj terminal)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	•		IBM_TDB	
-	373	((igbt or (semiconductor adj device)) and	USPAT;	2002/04/03 13:20
	•	(power adj terminal)) and terminals	US-PGPUB;	
) 		EPO; JPO;	
			DERWENT;	
			IBM TDB	
				<u> </u>

- SEMICONDUCTOR INTEGRATION ADJ CIRCUIT - CURRENT